



BSS84Z

Power MOSFET

-0.13A, -50V P-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

DESCRIPTION

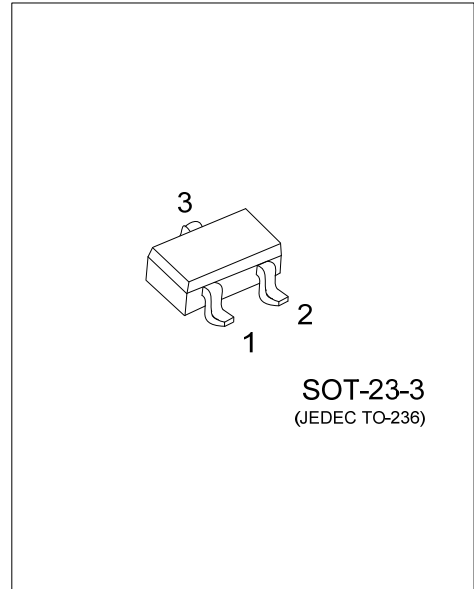
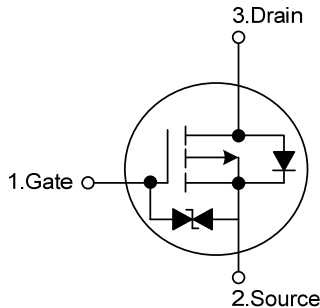
These P-Channel enhancement mode field vertical D-MOS transistors are in a SOT-23-3 SMD package, and in most applications they require up to -0.13A DC and can deliver current up to -0.52A.

This product is particularly suited to low voltage applications requiring a low current high side switch.

FEATURES

* $R_{DS(ON)} \leq 10 \Omega$ @ $V_{GS} = -4.5V$, $I_D = -0.1A$

SYMBOL



SOT-23-3
(JEDEC TO-236)

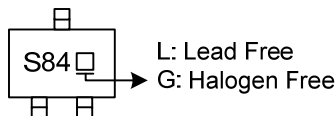
ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
BSS84ZL-AE2-R	BSS84ZG-AE2-R	SOT-23-3	G	S	D	Tape Reel

Note: Pin Assignment: G: Gate S: Source D: Drain

<p>BSS84ZG-AE2-R</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Green Package</p>	<p>(1) R: Tape Reel</p> <p>(2) AE2: SOT-23-3</p> <p>(3) G: Halogen Free and Lead Free, L: Lead Free</p>
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MARKING



■ ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage	V_{DSS}	-50	V
Gate-Source Voltage	V_{GSS}	± 20	V
Continuous Drain Current	DC	-0.13	A
	Pulse	-0.52	A
Power Dissipation	P_D	0.3	W
Junction Temperature	T_J	+150	$^\circ\text{C}$
Storage Temperature	T_{STG}	-55 ~ +150	$^\circ\text{C}$

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL DATA

PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	416 (Note)	$^\circ\text{C/W}$

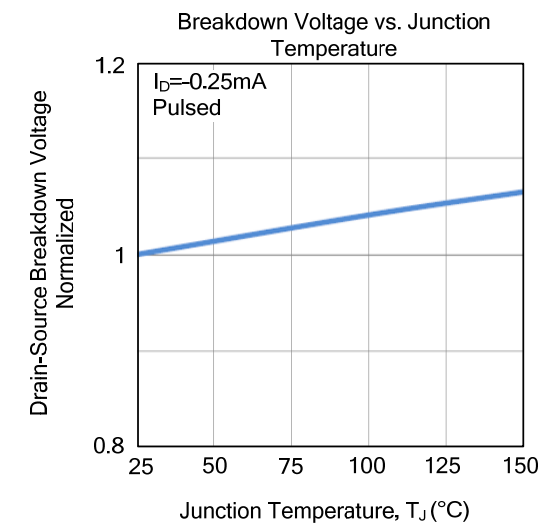
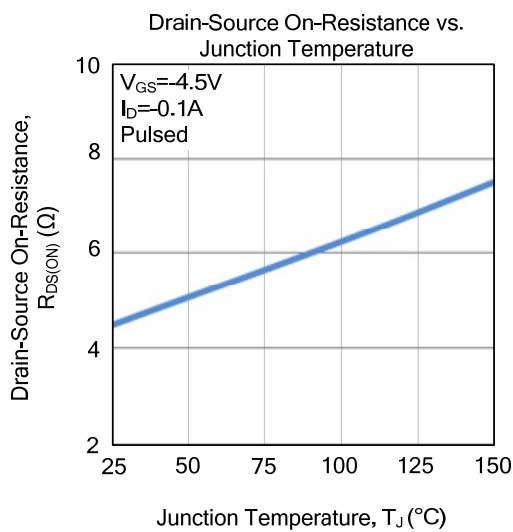
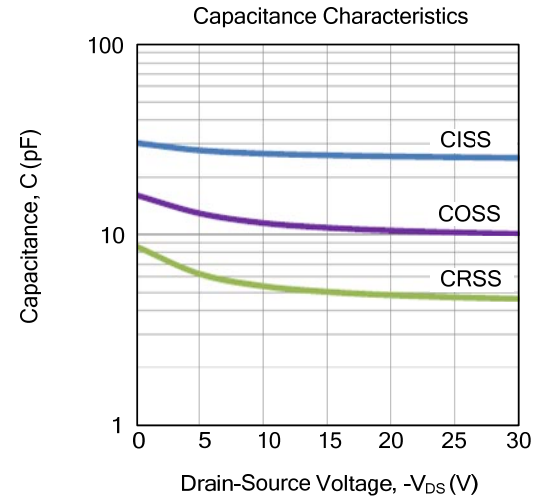
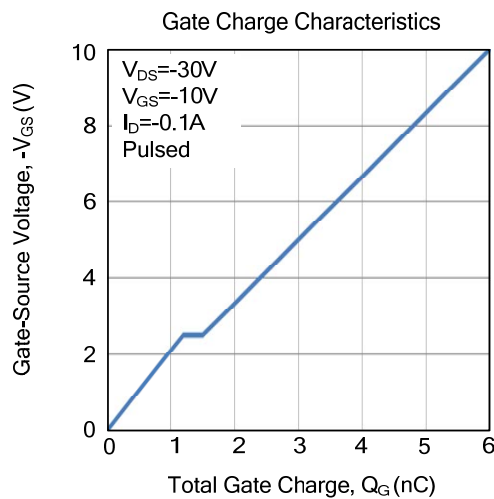
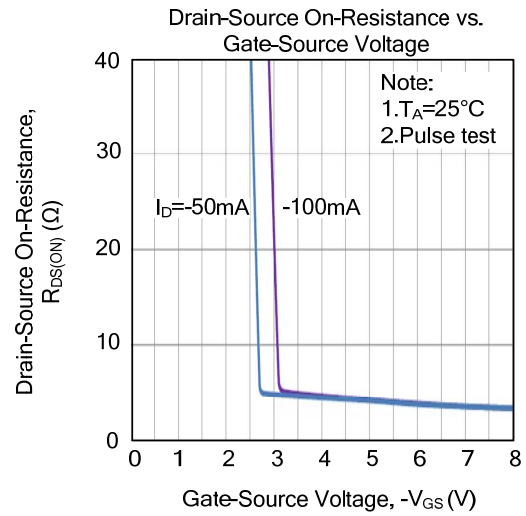
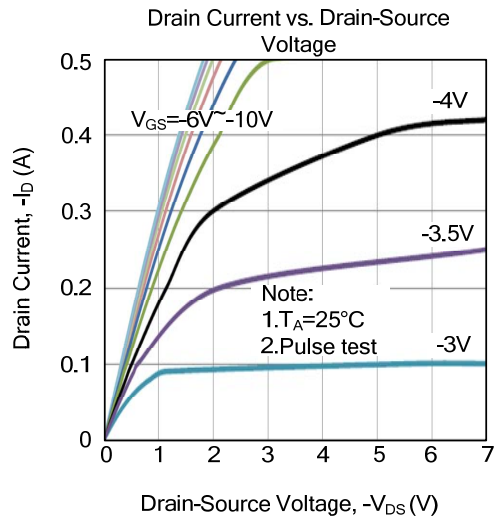
Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS ($T_A=25^\circ\text{C}$, unless otherwise specified)

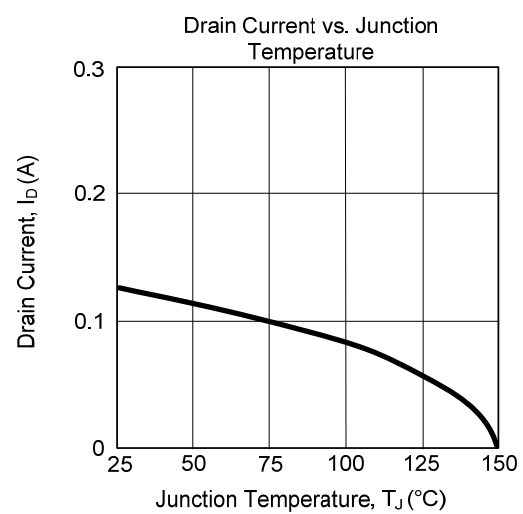
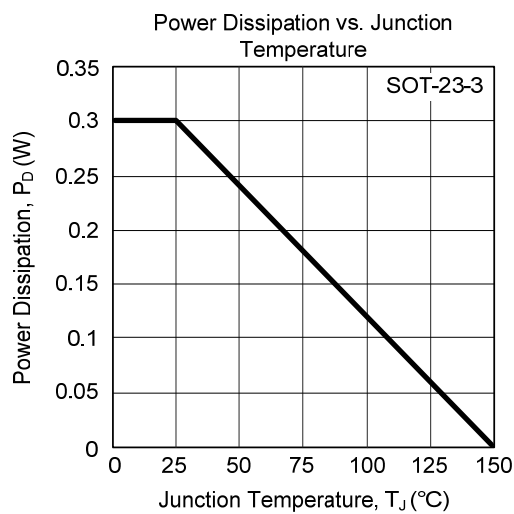
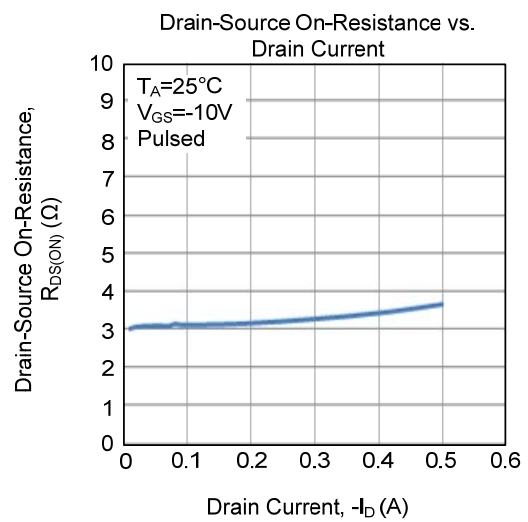
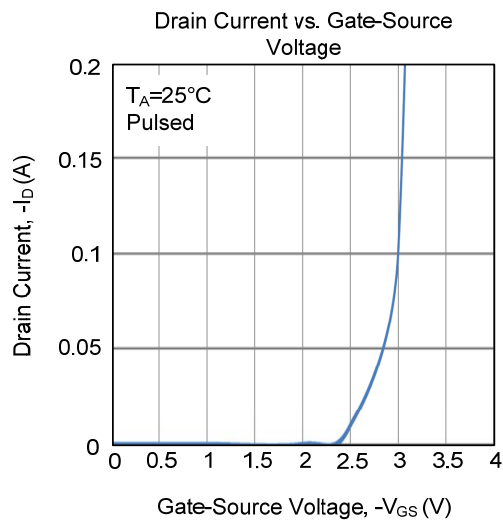
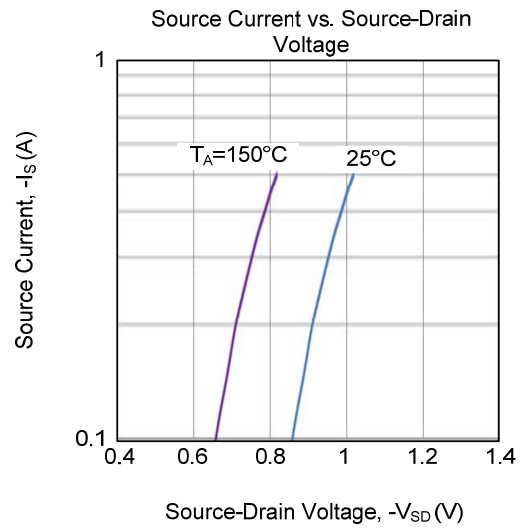
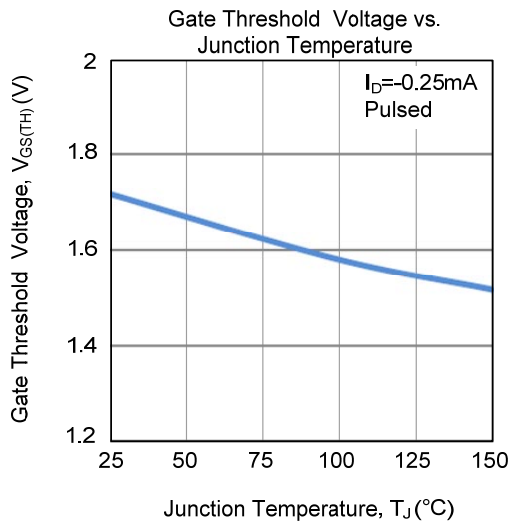
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-50			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-50V, V_{GS}=0V$			-15	μA
Gate-Body Leakage, Forward	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 20V$			± 10	μA
ON CHARACTERISTICS (Note)						
Gate-Threshold Voltage	$V_{GS(TH)}$	$V_{DS}=V_{GS}, I_D=-1mA$	-0.8	-1.7	-2.5	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-4.5V, I_D=-0.1A$			10	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C_{ISS}	$V_{DS}=-25V, V_{GS}=0V, f=1MHz$		25		pF
Output Capacitance	C_{OSS}			10		pF
Reverse Transfer Capacitance	C_{RSS}			4.8		pF
SWITCHING PARAMETERS (Note)						
Total Gate Charge	Q_G	$V_{DS}=-30V, V_{GS}=-10V, I_D=-0.1A$ (Note 1, 2)		6		nC
Gate Source Charge	Q_{GS}			1.2		nC
Gate Drain Charge	Q_{GD}			0.3		nC
Turn-ON Delay Time	$t_{D(ON)}$	$V_{DD}=-30V, V_{GS}=-10V,$ $I_D=-0.1A, R_G=3\Omega$ (Note 1, 2)		1.6		ns
Turn-ON Rise Time	t_R			20		ns
Turn-OFF Delay Time	$t_{D(OFF)}$			28		ns
Turn-OFF Fall-Time	t_F			32		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS						
Max. Diode Forward Current	I_S				-0.13	A
Pulsed Drain-Source Current	I_{SM}				-0.52	A
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS}=0V, I_S=-0.13A$ (Note)		-0.8	-1.2	V

Note: Pulse test, pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

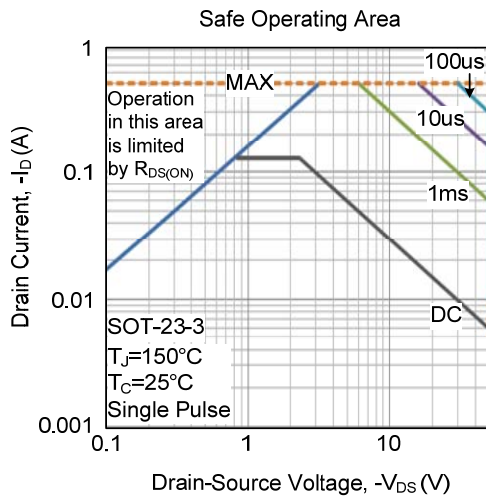
TYPICAL CHARACTERISTICS



■ TYPICAL CHARACTERISTICS (Cont.)



■ TYPICAL CHARACTERISTICS (Cont.)



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